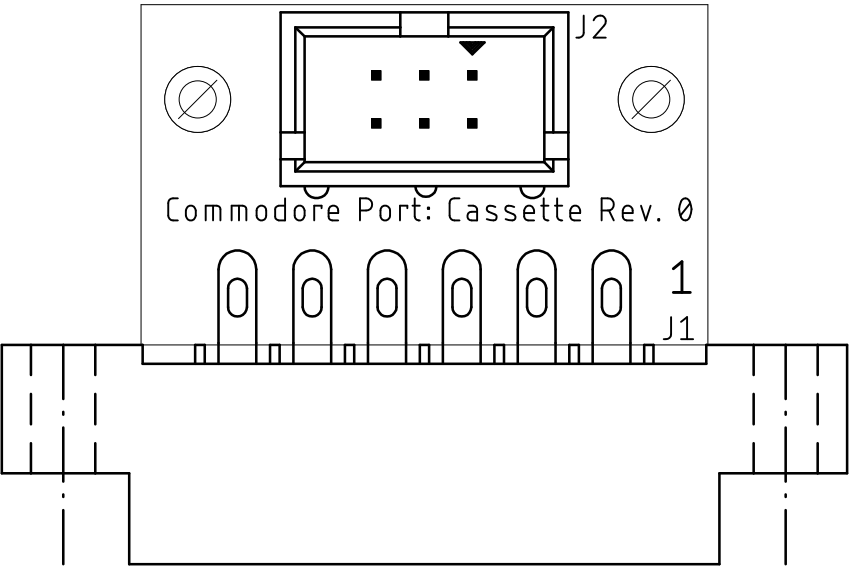
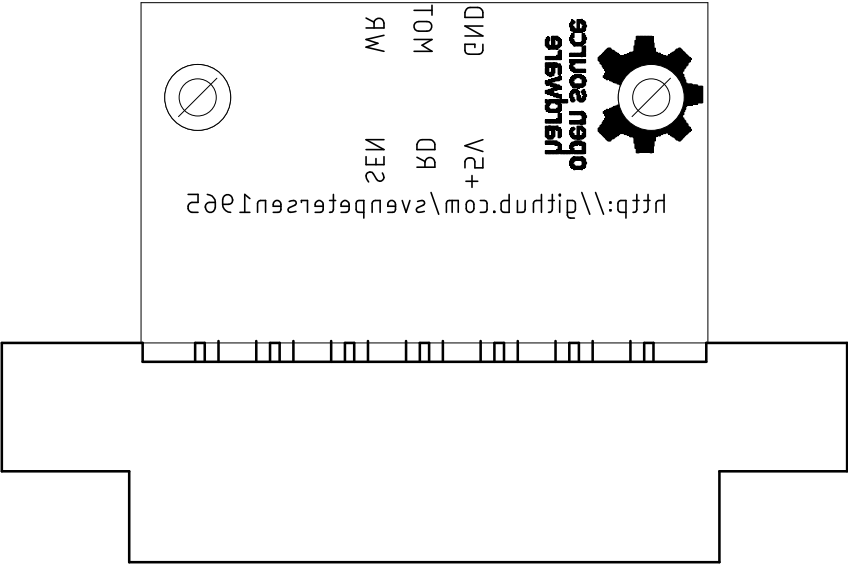


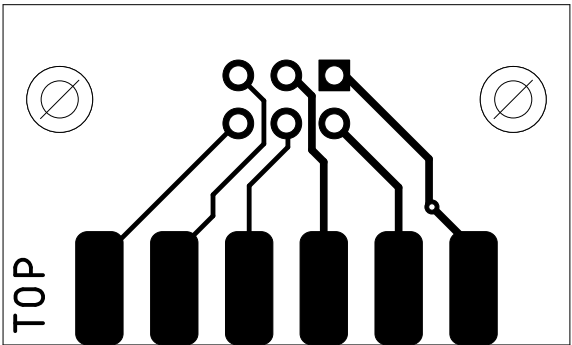
Sven Petersen 2022	Doc.-No.: 199-2-01-00	
	Cu: 35µm	Cu-Layers: 2
CPB_Cassette_Breakout		
nicht gespeichert!		Rev.: 0
placement component side		



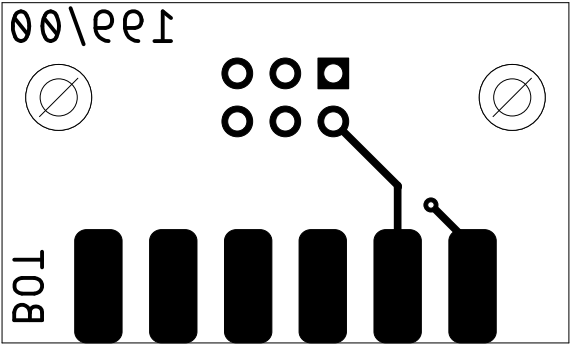
Sven Petersen 2022	Doc.-No.: 199-2-01-00	
	Cu: 35µm	Cu-Layers: 2
CPB_Cassette_Breakout		
12.11.2022 19:48		Rev.: 0
placement of the board		



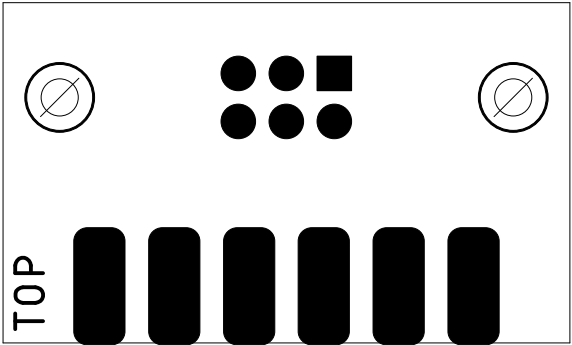
Sven Petersen 2022	Doc.-No.: 199-2-01-00	
	Cu: 35µm	Cu-Layers: 2
CPB_Cassette_Breakout		
12.11.2022 19:48		Rev.: 0
top		



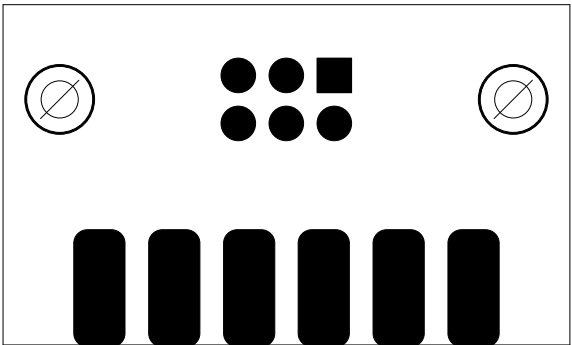
Sven Petersen 2022	Doc.-No.: 199-2-01-00	
	Cu: 35µm	Cu-Layers: 2
CPB_Cassette_Breakout		
12.11.2022 19:48		Rev.: 0
bottom		



Sven Petersen 2022	Doc.-No.: 199-2-01-00	
	Cu: 35µm	Cu-Layers: 2
CPB_Cassette_Breakout		
12.11.2022 19:48		Rev.: 0
stopmask component side		



Sven Petersen 2022	Doc.-No.: 199-2-01-00	
	Cu: 35µm	Cu-Layers: 2
CPB_Cassette_Breakout		
12.11.2022 19:48		Rev.: 0
stopmask solder side		



Sven Petersen 2022	Doc.-No.: 199-2-01-00	
	Cu: 35µm	Cu-Layers: 2
CPB_Cassette_Breakout		
nicht gespeichert!		Rev.: 0
placement component side		measures

